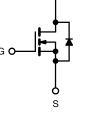




D Series Power MOSFET

PRODUCT SUMMARY			
V_{DS} (V) at T_J max.	550)	
R _{DS(on)} max. (Ω) at 25 °C	$V_{GS} = 10 V$	3.2	
Q _g max. (nC)	12		
Q _{gs} (nC)	2		
Q _{gd} (nC)	3		
Configuration	Single		





N-Channel MOSFET

FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (C_{iss})
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heatingMotor drives
- WOLDF UTIVES
- Battery chargers

ORDERING INFORMATION		
Package	DPAK (TO-252)	
Lead (Pb)-free	SiHD3N50D-E3	
Lead (Pb)-free and Halogen-free	SiHD3N50D-GE3	
	SiHD3N50DT1-GE3	
	SiHD3N50DT4-GE3	
	SiHD3N50DT5-GE3	

ABSOLUTE MAXIMUM RATINGS (T _C :	= 25 °C, unless otherwi	se noted)		
PARAMETER		SYMBOL	LIMIT	UNIT
Drain-Source Voltage		V _{DS}	500	
Gate-Source Voltage		N	± 30	V
Gate-Source Voltage AC (f > 1 Hz)		V _{GS}	30	
	$T_{\rm C} = 25 ^{\circ}{\rm C}$	- I _D -	3.0	
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $T_{C} = 100 ^{\circ}C$		1.9	А
Pulsed Drain Current ^a		I _{DM}	5.5	1
Linear Derating Factor			0.56	W/°C
Single Pulse Avalanche Energy ^b		E _{AS}	10.4	mJ
Maximum Power Dissipation		PD	69	W
Operating Junction and Storage Temperature Range		T _J , T _{stg}	-55 to +150	°C
Drain-Source Voltage Slope	T _J = 125 °C		24	
Reverse Diode dV/dt ^d		dV/dt -	0.22	V/ns
Soldering Recommendations (Peak Temperature) ^c for 10 s			300	°C

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b.
$$V_{DD} = 50$$
 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 3 A

c. 1.6 mm from case.

d. $I_{SD} \leq I_D$, starting $T_J = 25$ °C.

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THERMAL RESISTANCE RATINGS				
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W
Maximum Junction-to-Case (Drain)	R _{thJC}	-	1.8	0/11

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static		•			•	•	•
Drain-Source Breakdown Voltage	V _{DS}	V _{GS} =	= 0 V, I _D = 250 μA	500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.56	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	= V _{GS} , I _D = 250 μΑ	3	-	5	V
Gate-Source Leakage	I _{GSS}		V _{GS} = ± 30 V	-	-	± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	-	$= 500 \text{ V}, \text{ V}_{\text{GS}} = 0 \text{ V}$	-	-	1	μA
Durin Course On Otata Desistance			$V_{\rm S} = 0 \ V_{\rm T} \ T_{\rm J} = 125 \ ^{\circ}{\rm C}$	-	-	10	
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V		-	2.6	3.2	Ω
Forward Transconductance ^a	9 _{fs}	V _{DS}	= 8 V, I _D = 1.5 A	-	1	-	S
Dynamic							
Input Capacitance	C _{iss}	_	$V_{GS} = 0 V,$	-	175	-	
Output Capacitance	C _{oss}	_	V _{DS} = 100 V, f = 1 MHz	-	21	-	
Reverse Transfer Capacitance	C _{rss}			-	5	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	V_{DS} = 0 V to 400 V, V_{GS} = 0 V		-	21	-	pF
Effective Output Capacitance, Time Related ^c	C _{o(tr)}			-	26	-	
Total Gate Charge	Qg			-	6	12	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 V$	V _{GS} = 10 V I _D = 1.5 A, V _{DS} = 400 V		2	-	nC
Gate-Drain Charge	Q _{gd}			-	3	-	
Turn-On Delay Time	t _{d(on)}		V _{DD} = 400 V, I _D = 1.5 A R _g = 9.1 Ω, V _{GS} = 10 V		12	24	
Rise Time	t _r	V _{DD} =			9	18	
Turn-Off Delay Time	t _{d(off)}	$R_g =$			11	22	ns
Fall Time	t _f			-	13	26	
Gate Input Resistance	Rg	f = 1 MHz, open drain		-	3.3	-	Ω
Drain-Source Body Diode Characteristic	s					•	•
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse P - N junction diode		-	-	3	
Pulsed Diode Forward Current	I _{SM}			-	-	12	A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 1.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	-		-	293	-	ns
Reverse Recovery Charge	Q _{rr}		$T_{J} = 25 \ ^{\circ}C, I_{F} = I_{S} = 1.5 A,$		0.74	-	μC
Reverse Recovery Current	I _{RRM}	dl/dt = 100 A/µs, V _R = 20 V		-	5	-	A

Notes

a. Repetitive rating; pulse width limited by maximum junction temperature.

b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .

c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

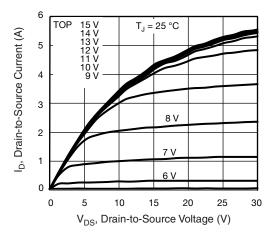


Fig. 1 - Typical Output Characteristics

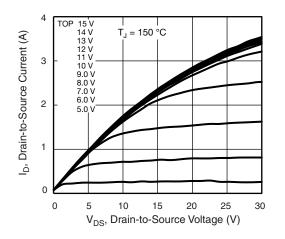
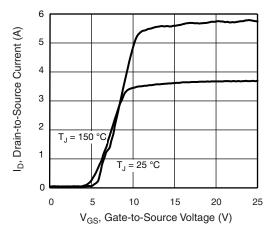


Fig. 2 - Typical Output Characteristics





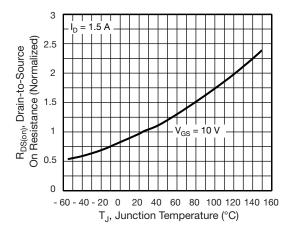


Fig. 4 - Normalized On-Resistance vs. Temperature

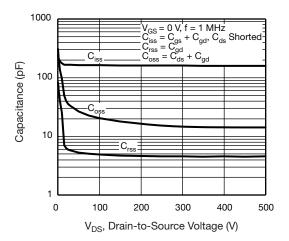


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

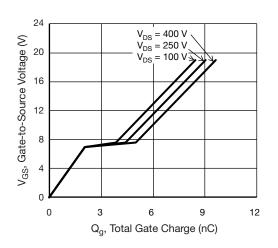


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage

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3 chnical questions, contact: hym@visha Document Number: 91495

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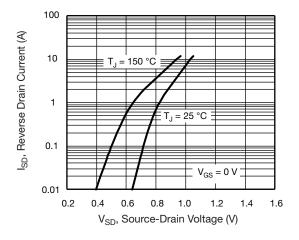
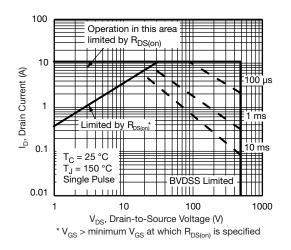


Fig. 7 - Typical Source-Drain Diode Forward Voltage





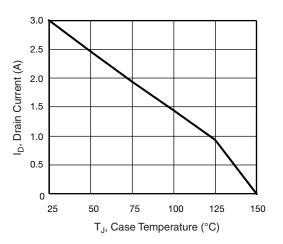


Fig. 9 - Maximum Drain Current vs. Case Temperature

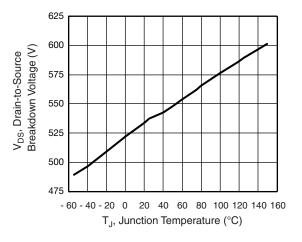
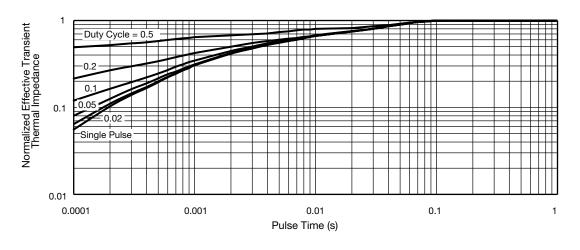


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature





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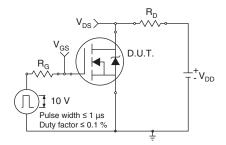


Fig. 12 - Switching Time Test Circuit

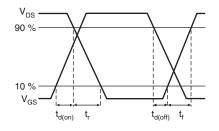


Fig. 13 - Switching Time Waveforms

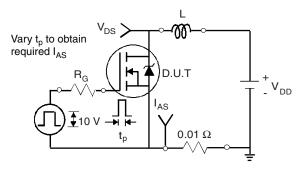


Fig. 14 - Unclamped Inductive Test Circuit

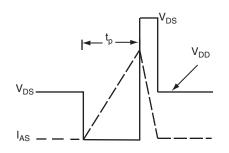


Fig. 15 - Unclamped Inductive Waveforms

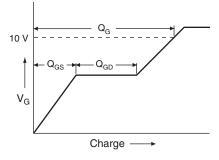


Fig. 16 - Basic Gate Charge Waveform

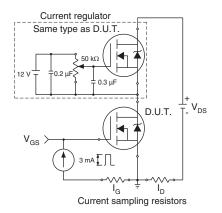
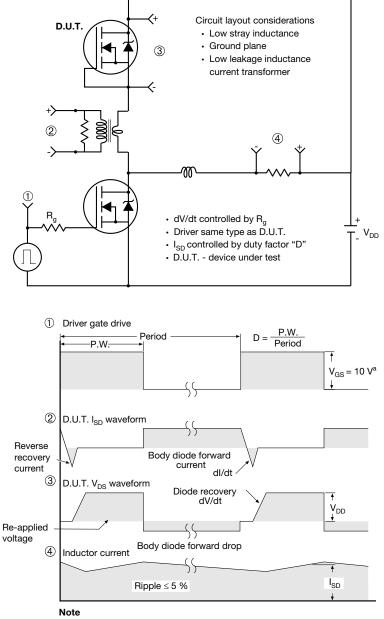


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



a. $V_{GS} = 5 V$ for logic level devices

Fig. 18 - For N-Channel

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TO-252AA Case Outline

VERSION 1: FACILITY CODE = Y







	MILLIMETERS		
DIM.	MIN.	MAX.	
А	2.18	2.38	
A1	-	0.127	
b	0.64	0.88	
b2	0.76	1.14	
b3	4.95	5.46	
С	0.46	0.61	
C2	0.46	0.89	
D	5.97	6.22	
D1	4.10	-	
E	6.35	6.73	
E1	4.32	-	
Н	9.40	10.41	
е	2.28 BSC		
e1	4.56 BSC		
L	1.40	1.78	
L3	0.89	1.27	
L4	-	1.02	
L5	1.01	1.52	

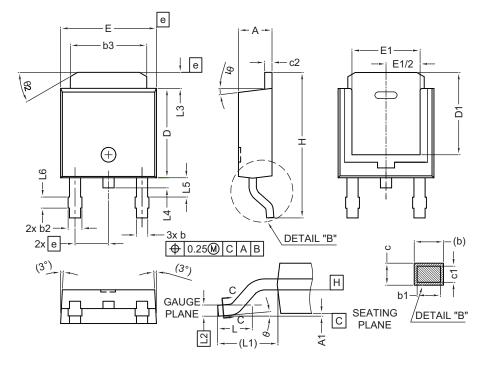
Note

• Dimension L3 is for reference only



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VERSION 2: FACILITY CODE = N



	MILLIMETERS		
DIM.	MIN.	MAX.	
A	2.18	2.39	
A1	-	0.13	
b	0.65	0.89	
b1	0.64	0.79	
b2	0.76	1.13	
b3	4.95	5.46	
С	0.46	0.61	
c1	0.41	0.56	
c2	0.46	0.60	
D	5.97	6.22	
D1	5.21	-	
E	6.35	6.73	
E1	4.32	-	
e	2.29 BSC		
Н	9.94	10.34	

	MILLIMETERS		
DIM.	MIN.	MAX.	
L	1.50	1.78	
L1	2.74	ref.	
L2	0.51	BSC	
L3	0.89	1.27	
L4	-	1.02	
L5	1.14	1.49	
L6	0.65	0.85	
θ	0°	10°	
θ1	0°	15°	
θ2	25°	35°	

Notes

• Dimensioning and tolerance confirm to ASME Y14.5M-1994

• All dimensions are in millimeters. Angles are in degrees

• Heat sink side flash is max. 0.8 mm

Radius on terminal is optional

ECN: E19-0649-Rev. Q, 16-Dec-2019 DWG: 5347



Vishay Siliconix

RECOMMENDED MINIMUM PADS FOR DPAK (TO-252)



Recommended Minimum Pads Dimensions in Inches/(mm)

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